

International **IR** Rectifier

INSULATED GATE BIPOLAR TRANSISTOR

PD-95909

IRG4PSC71UPbF

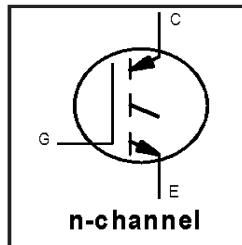
UltraFast Speed IGBT

Features

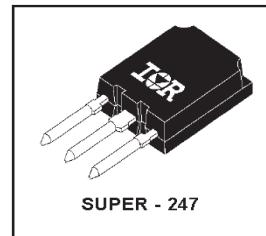
- UltraFast switching speed optimized for operating frequencies 8 to 40kHz in hard switching, 200kHz in resonant mode soft switching
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency (minimum switching and conduction losses) than prior generations
- Industry-benchmark Super-247 package with higher power handling capability compared to same footprint TO-247
- Creepage distance increased to 5.35mm
- Lead-Free

Benefits

- Generation 4 IGBT's offer highest efficiencies available
- Maximum power density, twice the power handling of the TO-247, less space than TO-264
- IGBTs optimized for specific application conditions
- Cost and space saving in designs that require multiple, paralleled IGBTs



$V_{CES} = 600V$
 $V_{CE(on)} \text{ typ.} = 1.67V$
 $\text{@ } V_{GE} = 15V, I_C = 60A$



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Breakdown Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	85⑥	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	60	
I_{CM}	Pulsed Collector Current ①	200	
I_{LM}	Clamped Inductive Load Current ②	200	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	180	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	350	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	140	
T_J	Operating Junction and	$-55 \text{ to } + 150$	
T_{STG}	Storage Temperature Range		$^\circ C$
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm from case))	

Thermal Resistance\ Mechanical

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	—	0.36	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	38	
	Recommended Clip Force	20.0(2.0)	—	—	N (kgf)
	Weight	—	6 (0.21)	—	g (oz)

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage ④	18	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.45	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}, I_C = 5.0\text{mA}$
$V_{\text{CE}(\text{ON})}$	Collector-to-Emitter Saturation Voltage	—	1.67	2.0	V	$I_C = 60\text{A}, V_{\text{GE}} = 15\text{V}$
		—	1.95	—		$I_C = 100\text{A}$
		—	1.71	—		See Fig.2, 5 $I_C = 60\text{A}, T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-10	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}, I_C = 1.0\text{mA}$
g_{fe}	Forward Transconductance ⑤	47	70	—	S	$V_{\text{CE}} = 50\text{V}, I_C = 60\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	500	μA	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}$
		—	—	2.0	μA	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 10\text{V}, T_J = 25^\circ\text{C}$
		—	—	5.0	mA	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 600\text{V}, T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	340	520	nC	$I_C = 60\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	44	66		$V_{\text{CC}} = 400\text{V}$
Q_{gc}	Gate - Collector Charge (turn-on)	—	160	240		See Fig. 8 $V_{\text{GE}} = 15\text{V}$
$t_{\text{d(on)}}$	Turn-On Delay Time	—	34	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 60\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$ Energy losses include "tail" See Fig. 10, 11, 13, 14
t_r	Rise Time	—	50	—		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	56	84		
t_f	Fall Time	—	86	130		
E_{on}	Turn-On Switching Loss	—	0.42	—	mJ	See Fig. 13, 14
E_{off}	Turn-Off Switching Loss	—	1.99	—		
E_{ts}	Total Switching Loss	—	2.41	3.2		
$t_{\text{d(on)}}$	Turn-On Delay Time	—	30	—	ns	$T_J = 150^\circ\text{C},$ $I_C = 60\text{A}, V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}, R_G = 5.0\Omega$ Energy losses include "tail" See Fig. 13, 14
t_r	Rise Time	—	49	—		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	129	—		
t_f	Fall Time	—	175	—		
E_{ts}	Total Switching Loss	—	4.5	—	mJ	See Fig. 13, 14
L_E	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	7500	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
C_{oes}	Output Capacitance	—	720	—		
C_{res}	Reverse Transfer Capacitance	—	93	—		

Notes:

- ① Repetitive rating; $V_{\text{GE}} = 20\text{V}$, pulse width limited by max. junction temperature. (See fig. 13b)
- ② $V_{\text{CC}} = 80\%(V_{\text{CES}})$, $V_{\text{GE}} = 20\text{V}$, $L = 10\mu\text{H}$, $R_G = 5.0\Omega$. (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.
- ⑤ Pulse width $5.0\mu\text{s}$, single shot.
- ⑥ Current limited by the package, (Die current = 100A)

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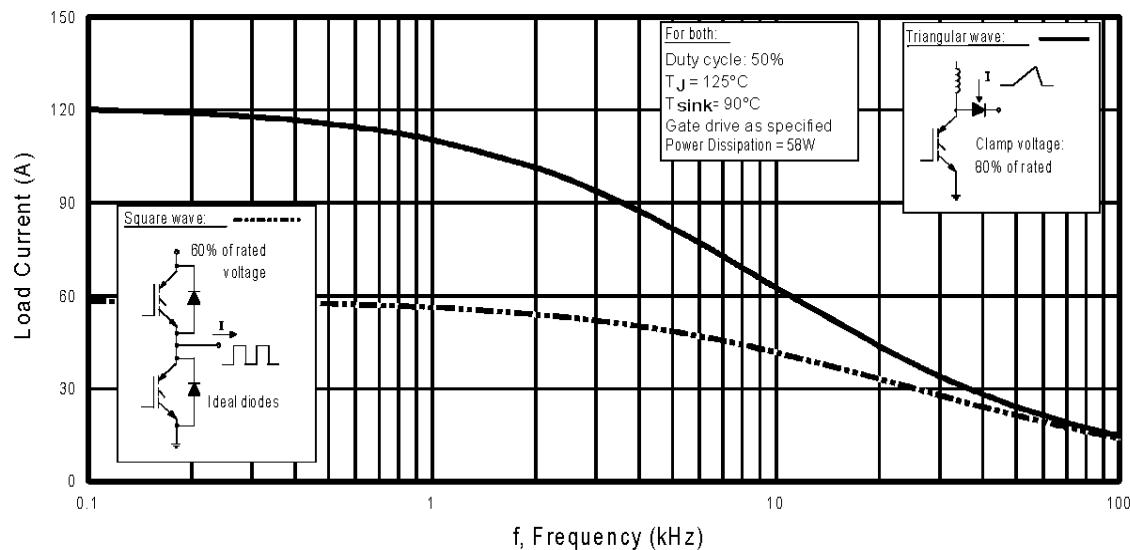


Fig. 1 - Typical Load Current vs. Frequency
 (For square wave, $I=I_{\text{RMS}}$ of fundamental; for triangular wave, $I=I_{\text{PK}}$)

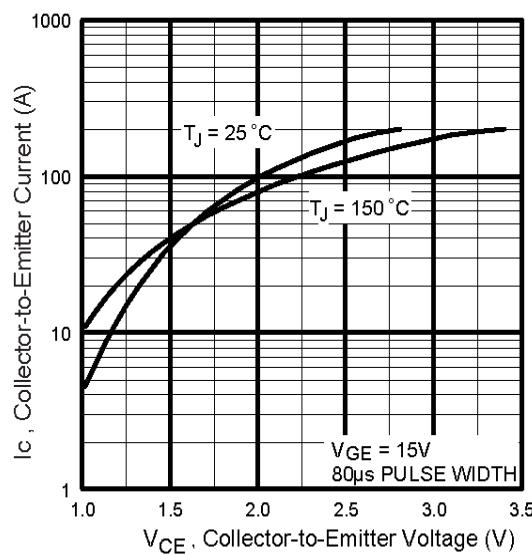


Fig. 2 - Typical Output Characteristics

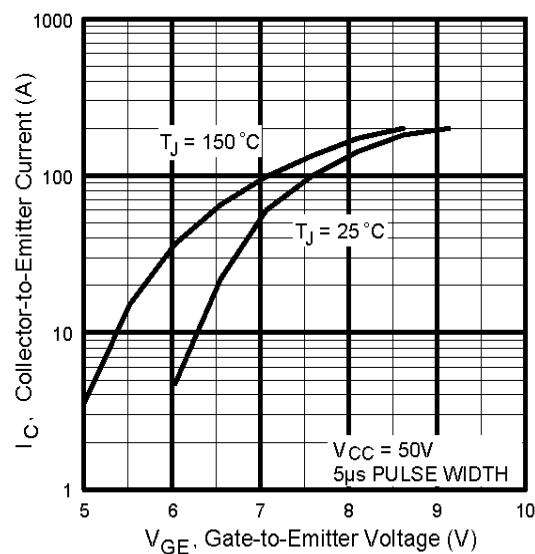


Fig. 3 - Typical Transfer Characteristics

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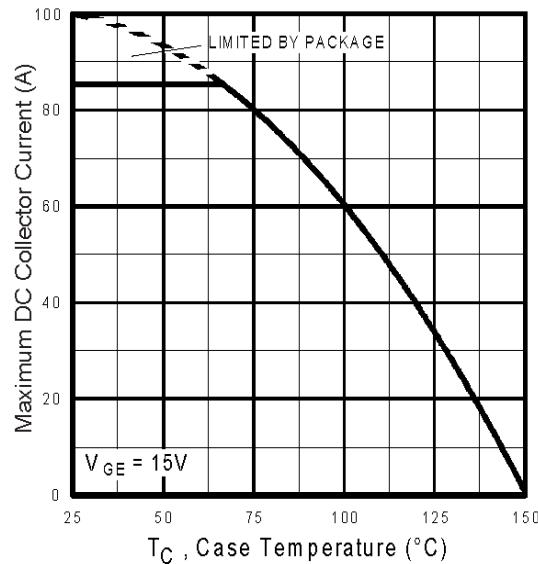


Fig. 4 - Maximum Collector Current vs. Case Temperature

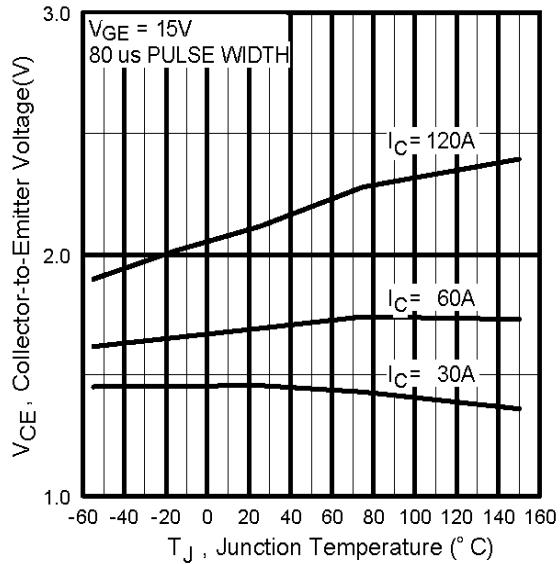


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

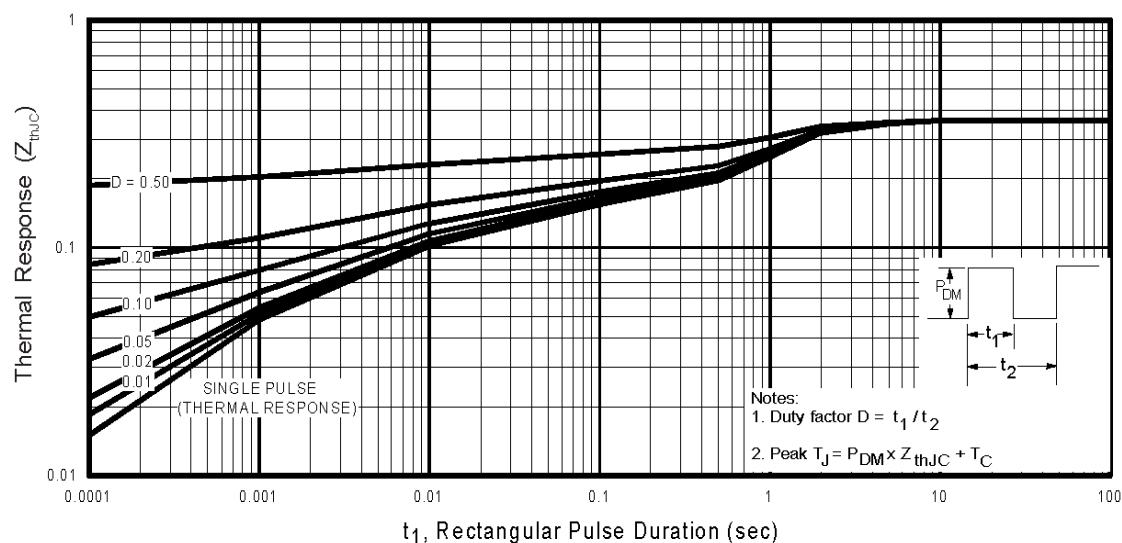


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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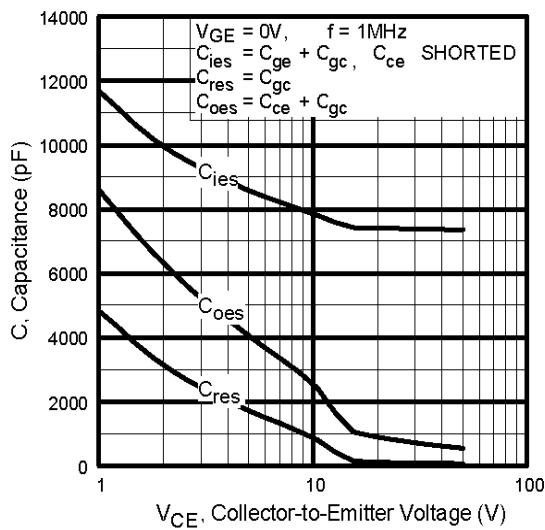


Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage

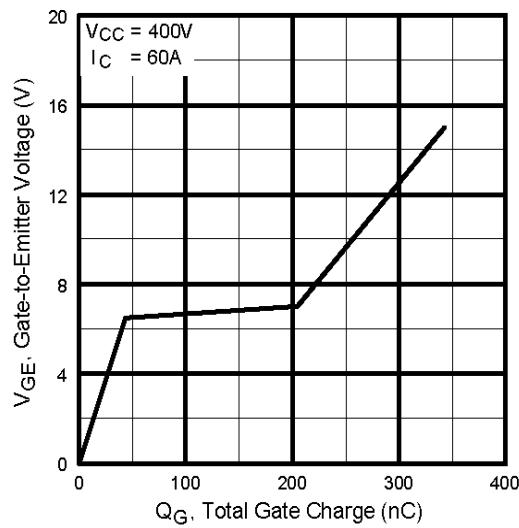


Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage

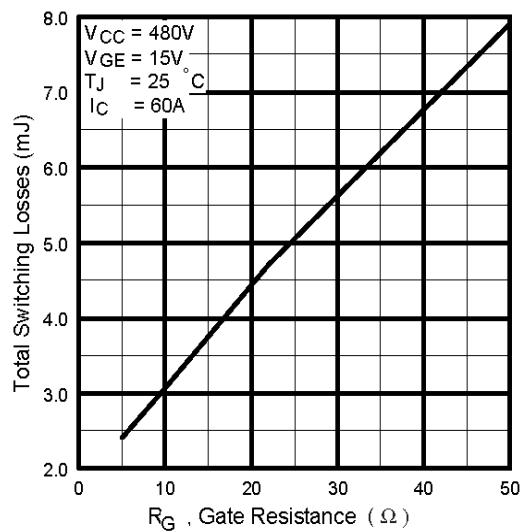


Fig. 9 - Typical Switching Losses vs. Gate
Resistance

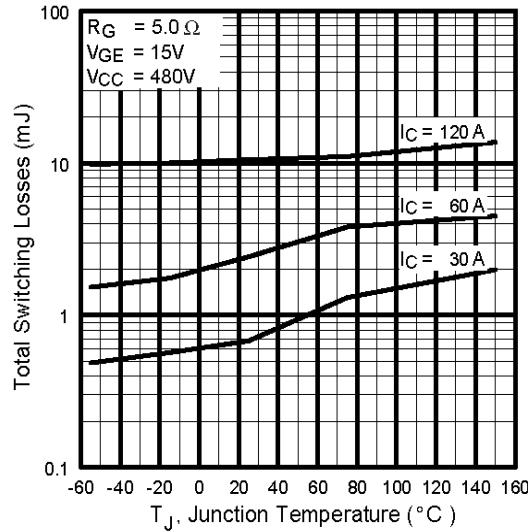


Fig. 10 - Typical Switching Losses vs.
Junction Temperature

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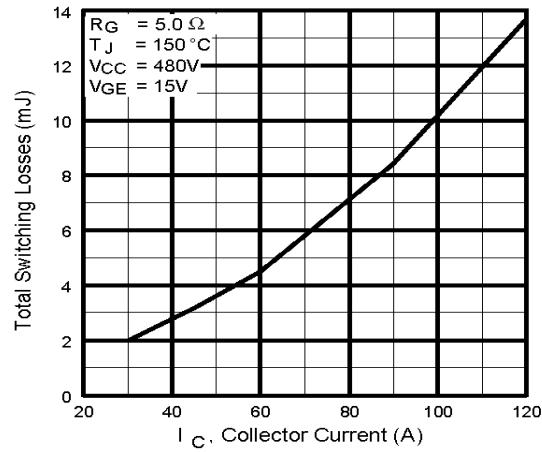


Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current

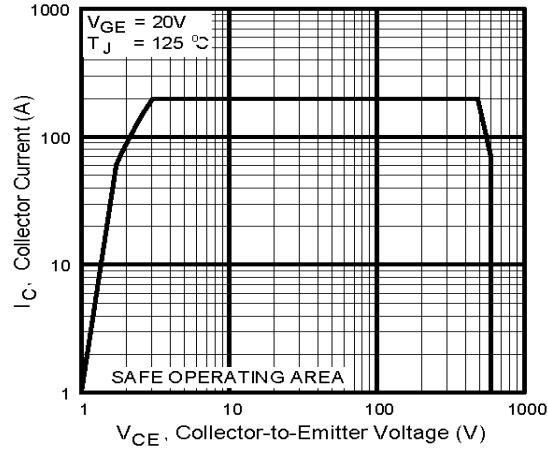
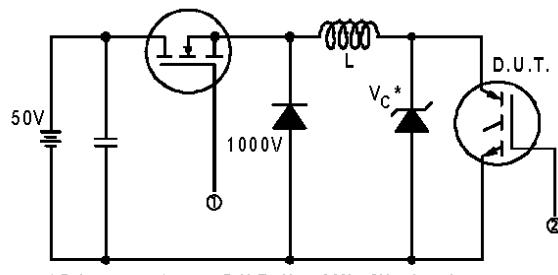


Fig. 12 - Turn-Off SOA

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* Driver same type as D.U.T.; $V_C = 80\%$ of $V_{ce(max)}$
 * Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated I_d .

Fig. 13a - Clamped Inductive Load Test Circuit

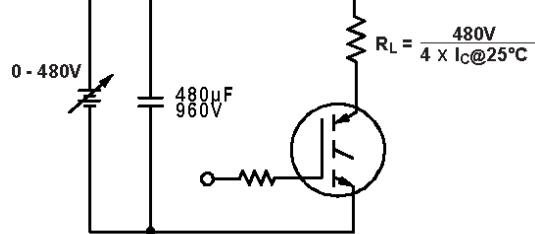


Fig. 13b - Pulsed Collector Current Test Circuit

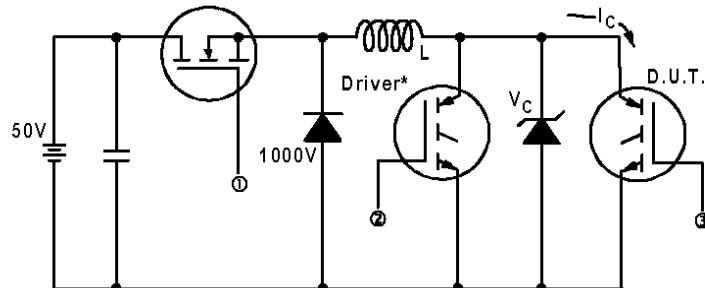


Fig. 14a - Switching Loss Test Circuit

* Driver same type as D.U.T., $V_C = 480V$

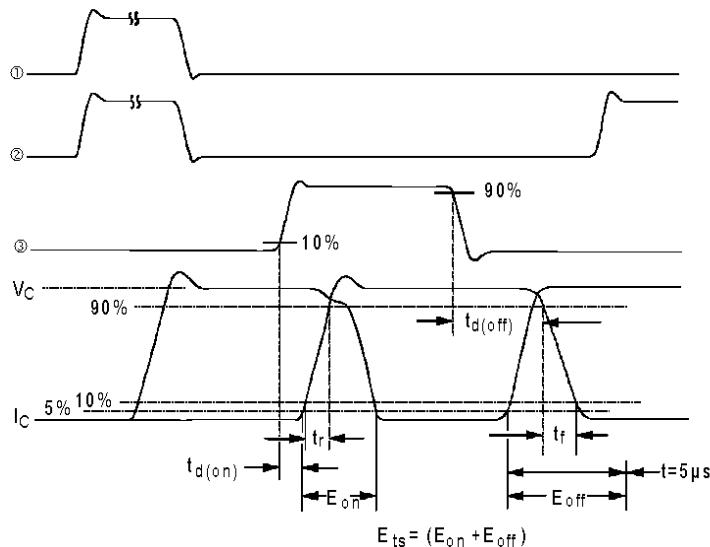
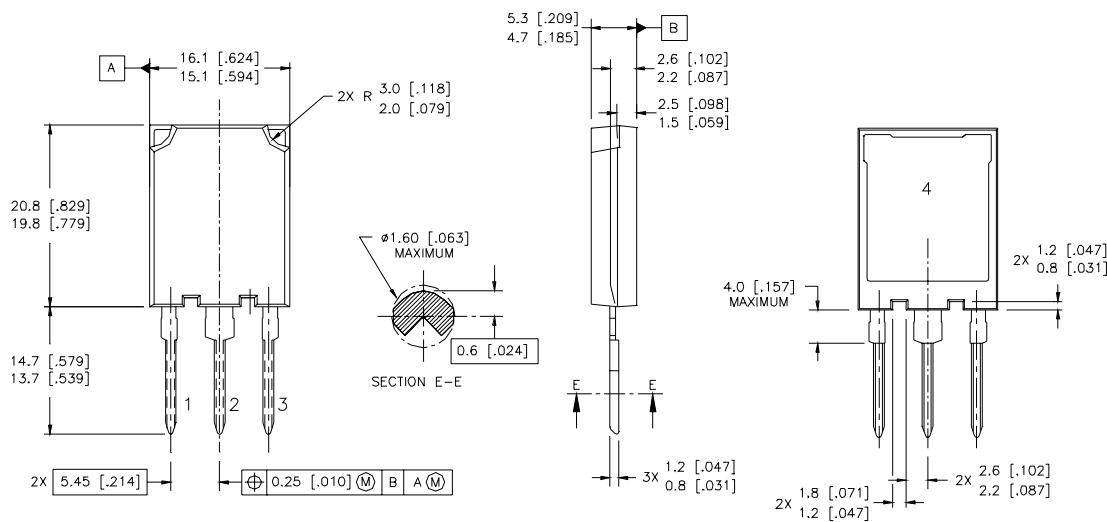


Fig. 14b - Switching Loss Waveforms

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Case Outline and Dimensions — Super-247

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NOTES:

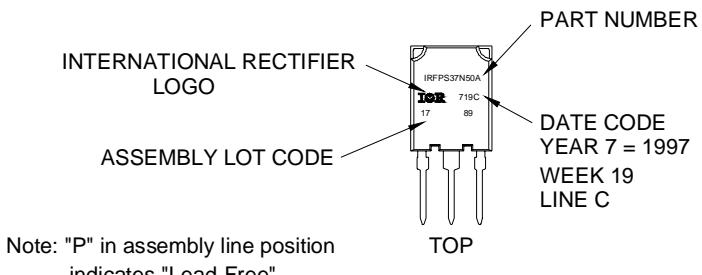
1. DIMENSIONS & TOLERANCING PER ASME Y14.5M-1994
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETRES [INCHES]

LEAD ASSIGNMENTS

MOSFET	IGBT
1 – GATE	1 – GATE
2 – DRAIN	2 – COLLECTOR
3 – SOURCE	3 – Emitter
4 – DRAIN	4 – COLLECTOR

Super-247 (TO-274AA) Part Marking Information

EXAMPLE: THIS IS AN IRFPS37N50A WITH
ASSEMBLY LOT CODE 1789
ASSEMBLED ON WW 19, 1997
IN THE ASSEMBLY LINE "C"



Note: "P" in assembly line position
indicates "Lead-Free"

Data and specifications subject to change without notice.

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[SGB15N120ATMA1](#) [NGTB50N60L2WG](#) [STGB10H60DF](#) [STGB20V60F](#) [STGB40V60F](#) [STGFW80V60F](#) [IGW40N120H3FKSA1](#)
[RJH60D7BDPQ-E0#T2](#) [APT40GR120B](#)